

# DATA SHEET SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade with Soft Termination

X7R |6 V to 250 V I nF to 4.7 uF RoHS compliant & Halogento Free



## YAGEO

SCOPE

This specification describes Automotive grade X7R series chip capacitors with flexible leadfree terminations and used for automotive equipments.

## APPLICATIONS

All general purpose applications Entertainment applications Comfort / security applications Information applications

## FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- Soldering is compliant with J-STD-020D
- Increased mechanical performance
- High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

## ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

## **GLOBAL PART NUMBER**

AS <u>XXXX</u> <u>X</u> <u>X</u> <u>XXX</u> <u>X</u> B <u>X</u> <u>XXX</u> (1) (2) (3) (4) (5) (6) (7)

## (I) SIZE - INCH BASED (METRIC)

0603 (1608) / 0805 (2012) / 1206 (3216)/ 1210 (3225)

## (2) TOLERANCE

- J = ±5%
- $K = \pm 10\%$
- $M = \pm 20\%$

## (3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- K = Blister taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch
- F = Blister taping reel; Reel 13 inch

## (4) TC MATERIAL

X7R

## (5) RATED VOLTAGE

7 = I6 V
8 = 25 V
9 = 50 V
V 001 = 0
A = 200 V
Y = 250 V

## (6) PROCESS

B = Class 2 MLCC

## (7) CAPACITANCE VALUE

2 significant digits + number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example:  $|2| = |2 \times |0| = |20 \text{ pF}$ 

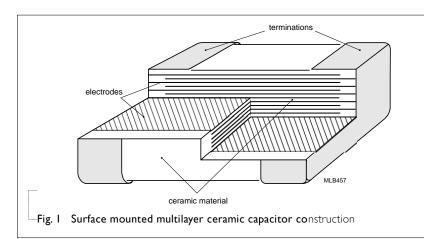


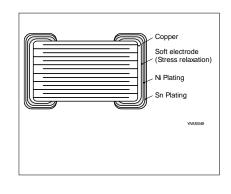
## **CONSTRUCTION**

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end flexible terminations and finally covered with a layer of plated tin (NiSn).

The terminations are lead-free. A cross section of the structure is shown in Fig.1 and Fig.2.





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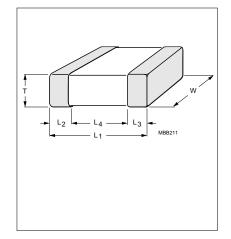
#### **DIMENSION**

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lable	el Forou	itlines see fig.	3			
TYPE	LI (mm)	W (mm)	T (mm)	L2/L3(mm) min	L2/L3(mm) max	L4(mm) min
0603	1.6 ± 0.2	$0.8 \pm 0.15$	0.8 ± 0.15	0.20	0.65	0.50
0805	2.0 ± 0.3	1.25 ± 0.2	0.85 ± 0.15	- 0.25	0.75	0.70
1206	3.2 ± 0.4	1.6 ± 0.2	$0.85 \pm 0.15$ 1.25 ± 0.20 1.60 ± 0.20	0.25	0.85	1.50
1210	3.2 ± 0.5	2.5 ± 0.3	2.5 ± 0.3	0.25	1.00	1.20

## OUTLINES



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Surface-Mount Ceramic Multilayer Capacitors Soft termination X7R 16 V to 250 V

Table 2 Size	0805						
CAP.	0603				0805		
	16 V	25 V	50 V	100 V	25 V	50 V	100 V
I.0 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
I.5 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
2.2 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
3.3 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
4.7 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
6.8 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
10 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
15 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
22 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
33 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	1.25±0.2
47 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	1.25±0.2
68 nF	0.8±0.15	0.8±0.15	0.8±0.15		1.25±0.2	1.25±0.2	1.25±0.2
100 nF	0.8±0.15	0.8±0.15	0.8±0.15		1.25±0.2	1.25±0.2	1.25±0.2
l uF					1.25±0.2		

## CAPACITANCE RANGE & THICKNESS FOR X7R

### ΝΟΤΕ

Values in shaded cells indicate thickness class in mm

Table 3	Size 1206								
CAP.	1206					1210			
	16V	25V	50 V	100 V 2	200 V / 250 V	50V	100V	200 V	250 V
22 nF					1.25±0.2				
33 nF					1.25±0.2				
47 nF					1.25±0.2				
68 nF					1.25±0.2				
100 nF		0.85±0.15	0.85±0.15	1.25±0.2	1.6±0.2		1.25±0.2	1.25±0.2	1.25±0.2
150 nF		1.25±0.2	1.25±0.2	1.25±0.2			1.25±0.2	1.25±0.2	1.25±0.2
220 nF	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2			1.25±0.2	1.25±0.2	1.25±0.2
4.7 uF						2.5±0.3			

## CAPACITANCE RANGE & THICKNESS FOR X7R

#### NOTE

Values in shaded cells indicate thickness class in mm



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Surface-Mount Ceramic Multilayer Capacitors Soft termination X7R 16 V to 250 V

## THICKNESS CLASSES AND PACKING QUANTITY

Table 5

SIZE	$\begin{array}{c c c c c c c c } \hline \textbf{DE} & \textbf{CLASSIFICATION} & \textbf{QUAN}^{T} \\ \hline \textbf{03} & 0.8 \pm 0.15 \text{ mm} \\ \hline \textbf{06} & \hline 0.85 \pm 0.15 \text{ mm} \\ \hline 1.25 \pm 0.2 \text{ mm} \\ \hline 0.6 \pm 0.1 \text{ mm} \\ \hline 0.85 \pm 0.1 \text{ mm} \\ \hline 1.25 \pm 0.2 \text{ mm} \\ \hline 1.25 \pm 0.2 \text{ mm} \\ \hline 1.6 \pm 0.2 \text{ mm} \\ \hline \end{array}$	TAPE WIDTH -	Ø180	MM / 7 INCH	Ø330	MM / 13 INCH
CODE		QUANTITY PER REEL	Paper	Blister	Paper	Blister
0603	0.8 ±0.15 mm	8 mm	4,000		15,000	
0805	0.85 ±0.15 mm	8 mm	4,000		15,000	
0805	1.25 ±0.2 mm	8 mm		3,000		10,000
	0.6 ±0.1 mm	8 mm	4,000		20,000	
1206	0.85 ±0.1 mm	8 mm	4,000		15,000	
1206	1.25 ±0.2 mm	8 mm		3,000		10,000
	1.6 ±0.2 mm	8 mm		2,000		10,000
1210	2.5 ±0.3 mm	8 mm		1,000		

#### ELECTRICAL CHARACTERISTICS

## NP0/X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 6						
DESCRIPTION						VALUE
Capacitance range					l r	nF to 4.7 uF
Capacitance tolerand	ce					
X7R					±5% <sup>(I)</sup> , ±	10%, ±20%
Dissipation factor (D	D.F.)					
X7R		0603	0805	1206	1210	
	16V	InF to 100nF		220nF		≤ 3.5%
	25V	InF to 39nF	InF to 100nF	100nF to 220nF		≤ 2.5%
		47nF to 100nF				≤ 3.5%
			ΙμF			≤ 5%
	50V	InF to 39nF	InF to 100nF	100nF to 220nF		≤ 2.5%
		47nF to 100nF				≤ 3.5%
					4.7 uF	$\leq 10\%$
	100V	InF to 10nF	InF to 100nF	100nF to 220nF		≤ 2.5%
		I 2nF to 47nF				≤ 5%
20	0V / 250V			22nF to 100nF		≤ 2.5%
Insulation resistance minute at U <sub>r</sub> (DC)	after I			$IR \ge 10 \text{ G}\Omega \text{ or } I.R \times$	C ≥ 500Ω.F which	never is less
Maximum capacitanc function of temperat (temperature charac X7R	ture					1150/
						±15%
Operating temperate X7R	ure range:				_55 °⊂ 1	:o +125 °C
					55 61	

#### NOTE

I. Capacitance tolerance ±5% doesn't available for X7R full product range, please contact local sales force before order



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#### SOLDERING RECOMMENDATION

Table 7

SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
Reflow	≥ 0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

#### SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

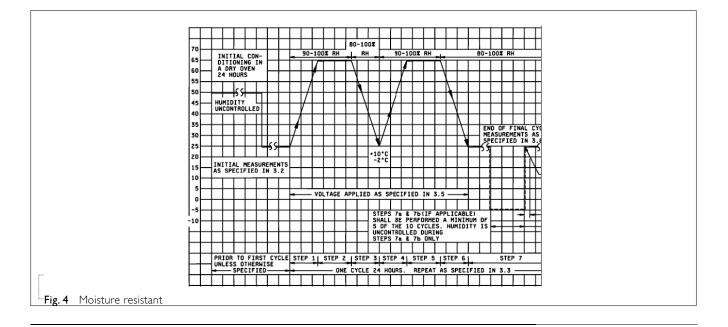
## TESTS AND REQUIREMENTS

Table 8 Test procedures and requirements

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage	
Capacitance	IEC 60384- 21/22	4.5.1	At 20°C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V <sub>rms</sub> at 20°C	Within specified tolerance	
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V <sub>rms</sub> at 20°C	In accordance with specification	
Insulation Resistance	IEC 60384- 21/22	4.5.3	At $U_r$ (DC) for 1 minute	In accordance with specification	

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TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
High Temperature Exposure	AEC-Q200	3	Unpowered ; 1000hours @ T=150°C Measurement at 24±2 hours after test conclusion.	No visual damage ΔC/C : X7R: ±10% D.F.: within initial specified value IR: within initial specified value
Temperature Cycling	AEC-Q200	4	Preconditioning; 150 +0/–10°C for 1 hour, then keep for 24 ±1 hours at room temperature 1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours	No visual damage ΔC/C X7R: ±10% D.F. meet initial specified value IR meet initial specified value
Destructive Physical Analysis	AEC-Q200	5	Note: Only applies to SMD ceramics. Electrical test not required.	
Moisture Resistance	AEC-Q200	6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 ±2 hours after test condition.	No visual damage ΔC/C X7R: ±10% D.F. Within initial specified value IR X7R: Meet initial specified value



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TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
Biased Humidity	AEC-Q200	7	<ul> <li>I. Preconditioning, class 2 only:</li> <li>I50 +0/-10 °C /1 hour, then keep for</li> <li>24 ±1 hour at room temp</li> <li>2 Initial management</li> </ul>	No visual damage after recovery ΔC/C
			2. Initial measure: Parameter: Cap, D.F., I.R. Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ	X7R: ±15% D.F.
			<ol> <li>Test condition:</li> <li>85 °C, 85% R.H. connected with 100 KΩ resistor, applied</li> <li>1.5V/Ur for 1,000 hours.</li> </ol>	Less than 200% of initial spec. I.R. The insulation resistance shall
			4. Recovery: Class2: 24 ±2 hours	greater than 10% of initial spec
			5. Final measure: Cap, D.F., I.R.	
Operational Life	AEC-Q200	8	<ol> <li>Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for</li> </ol>	No visual damage
			24 ± 1 hour at room temp 2. Initial measure:	ΔC/C X7R: ±15%
			<ul> <li>Spec: refer to initial spec C, D, IR</li> <li>3. Endurance test: <ul> <li>Temperature: X7R: 125 °C</li> <li>Specified stress voltage applied for 1,000 hours:</li> <li>Applied 2.0 × U<sub>r</sub> for general products</li> <li>Applied 1.5 × U<sub>r</sub> for high cap. Products</li> </ul> </li> </ul>	D.F. Less than 200% of initial spec. IR The insulation resistance shall
			High voltage series follows with below stress condition:	be greater than 10% of initial spec.
			Applied 1.5 $\times$ Ur for 200V, 250V series	
			4. Recovery time: $24 \pm 2$ hours	
			5. Final measure: C, D, IR	
			Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to " <i>IEC</i> 60384 4.1" and then the requirement shall be met.	
External Visual	AEC-Q200	9	Any applicable method using × 10 magnification	In accordance with specification
Physical Dimension	AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification
Mechanical Shock	AEC-Q200	13	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's	ΔC/C X7R: ±10%
			Duration: 0.5 ms	D.F.
			Velocity change: 15.4 ft/s Waveform: Half-sin	Within initial specified value IR
				Within initial specified value

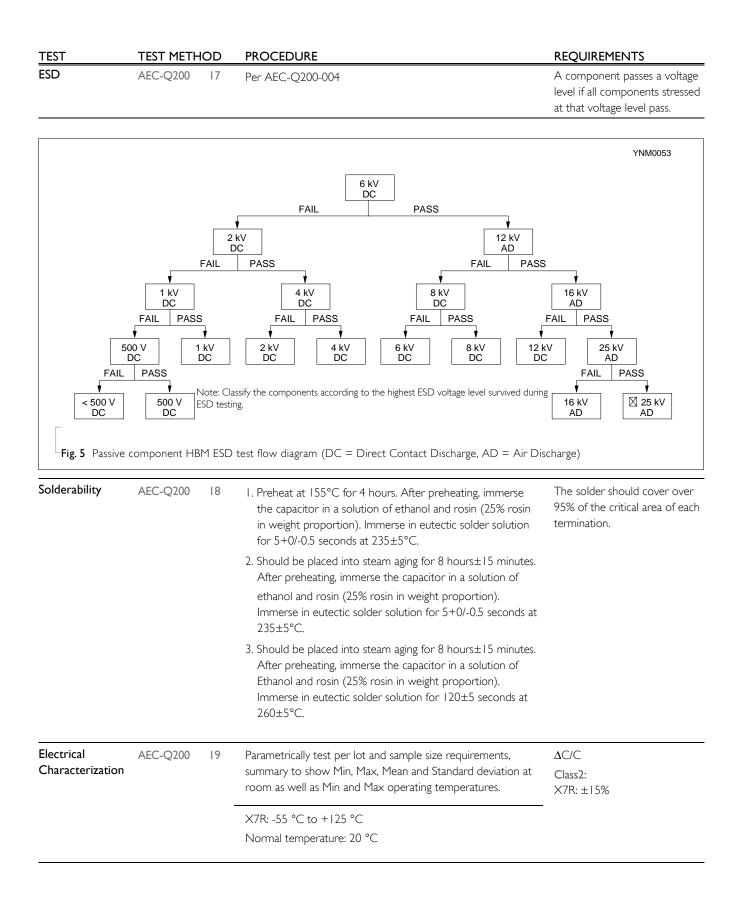
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 Surface-Mount Ceramic Multilayer Capacitors
 Soft termination
 X7R
 16 V to 250 V

TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS	
Vibration	AEC-Q200	14	5 g's for 20 minutes, 12 cycles each of 3 orientations. Note:	ΔC/C X7R: ±10%	
			Use 8'' × 5'' PCB. 0.31'' thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2'' from any secure point. Test from 10-2000 Hz.	D.F: meet initial specified value IR meet initial specified value	
Resistance to Soldering Heat	AEC-Q200	15	Precondition: 150 +0/–10 °C for 1 hour, then keep for 24 $\pm$ 1 hours at room temperature Preheating: for size $\leq$ 1206: 120 °C to 150 °C for 1 minute Preheating: for size $>$ 1206: 100 °C to 120 °C for 1 minute	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned	
			and 170 °C to 200 °C for 1 minute	ΔC/C	
				Solder bath temperature: 260 $\pm$ 5 °C Dipping time: 10 $\pm$ 0.5 seconds	Class2: X7R: ±10%
			Recovery time: 24 $\pm$ 2 hours	D.F. within initial specified value	
				IR within initial specified value	
Thermal Shock	AEC-Q200	16	I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room .	No visual damage	
			temp	ΔC/C	
			2. Initial measure:	X7R: ±15%	
			Spec: refer to initial spec C, D, IR		
			3. Rapid change of temperature test:		
			-55 °C to +125 °C; 300 cycles	D.F: meet initial specified value	
			15 minutes at lower category temperature; 15 minutes at upper category temperature.	IR meet initial specified value	
			4. Recovery time:		
			Class 2: 24 ±2 hours		
			5. Final measure: C, D, IR		

## Surface-Mount Ceramic Multilayer Capacitors Soft termination X7R 16 V to 250 V



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TEST	TEST METHOD		PROCEDURE	REQUIREMENTS				
Board Flex	AEC-Q200	21	Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick and has a layer-thickness 35 µm ± 10 µm. Part should be mounted using the following soldering reflow profile. Conditions: Class2: Bending 5 mm at a rate of 1 mm/s, radius jig 230 mm	No visib ΔC/C Class2: X7R: ±1		age		
			Test Substrate:		Dimen	ision(m	m)	
			↓ 04.5 <sup>VNSC147</sup>	Туре	а	b	, c	
				0201	0.3	0.9	0.3	
				0402	0.4	1.5	0.5	
				0603	1.0	3.0	1.2	
				0805	1.2	4.0	1.65	
			100	1206	2.2	5.0	1.65	
			unit: mm	1210	2.2	5.0	2.0	
				1808	3.5	7.0	3.7	
Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. * Apply 2N force for 0402 size.	Magnifica may be e inspectic integrity terminals junction. Before a device sl electrica in this sp	employ on of th of the s and b nd afte nall con requir	red for device ody/ter r the te nply wir rements	nanical body, minal est, the th all	
Beam Load Test	AEC-Q200	23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	≤ 0805 Thickne Thickne ≥ 1206 Thickne Thickne	ss ≤ 0.5 ss ≥1.2	5 mm: { .5 mm:	8N 54N	
Voltage Proof	IEC 60384-1	4.6	Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur 100 V < Ur ≤ 200 V series applied (1.5 Ur + 100) 200 V < Ur ≤ 500 V series applied (1.3 Ur + 100) Charge/Discharge current is less than 50mA	No bre	akdowr	n or flas	shover	

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 Surface-Mount Ceramic Multilayer Capacitors
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## <u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 3	Nov. 28, 2022	-	- Update Biased Humidity and operation life requirements.
Version 2	Dec. 21, 2020	-	- Add X7R product range, 0603, InF to 15nF, 16 to 100V
Version I	Dec. 04, 2018	-	- Add 0603/ 22nF to 100nF
Version 0	Oct. 05, 2017	-	- New

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